

					PTO/SB/21 (08-00)		
TRANSMITTAL FORM			Application Number		09/699,466		
			Filing Date		October 31, 2000		
			First Named Inventor		Shunpei YAMAZAKI et al.		
			Group Art Unit	Î	2829		
(to be used for all correspondence after initial filing)			Examiner Name		A. Sarkar		
Total Number of Pages in This Submission			Attorney Docket Number	r	0756-2222		
ENCLOSURES (check all that apply)							
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ocket No. 0756-2222

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In re F	Patent Application of)	Art Unit: 2829		
Shunp	oei YAMAZAKI et al.)	Examiner: A. Sarkar		
Serial	No. 09/699,466)	CERTIFICATE OF MAILING		
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SUPPLEMENTAL AMENDMENT

Honorable Commissioner of Patents

Washington, D.C. 20231

Sir:

Further to the Amendment filed on May 20, 2002 please amend the above-lied application as follows:

E CLAIMS:

Please amend claims 10, 19, 20 and 25 as follows: identified application as follows:

IN THE CLAIMS:

-(Amended) A method according to claim 7, wherein said crystallization promoting material is selected from the group consisting of Fe, Co, Ni, Ru, Rh, Pd, Os, Ir, Pt, Cu and Au.

79. (Amended) A method according to claim 15, wherein said crystallization promoting material is selected from the group consisting of Fe, Co, Ni, Ru, Rh, Pd, Os, Ir, Pt, Cu and Au.

> -(-Twice Amended) A method for manufacturing a semiconductor device comprising the steps of:

> > forming a semiconductor film on an insulating surface; providing a crystallization promoting material onto said semiconductor film;